TEMPROBETM

Most Efficient Concept in Reflow Thermal Profiling

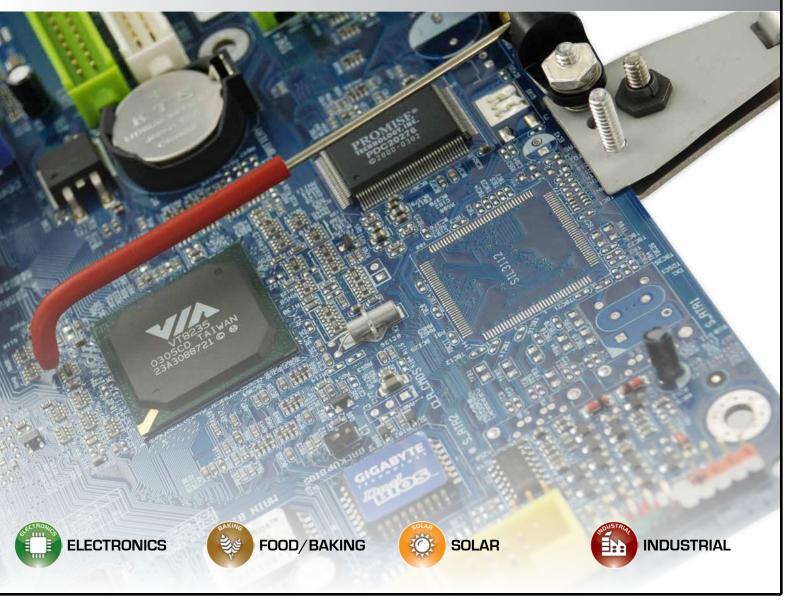


TEMPROBE™ is a patented, precision temperature sensing instrument for easy non-destructive profiling. The subminiature thermocouple tip can be placed anywhere on a board, including profiling in wet solder paste or on fine pitch component legs. TEMPROBETM is used in place of a conventional thermocouple to monitor the temperature of critical solder joints or components in soldering and rework processes. TEMPROBE™ is compatible with all thermal profilers.



www.ecd.com/products/temprobe





Accurately senses component temporal

SLIDING BALL JOINT

3 dimensional positioning of the thermocouple tip on the test product. Lever locks the ball joint securing the tip into place on the PCB.



CLIP, POSITION & PROFILE

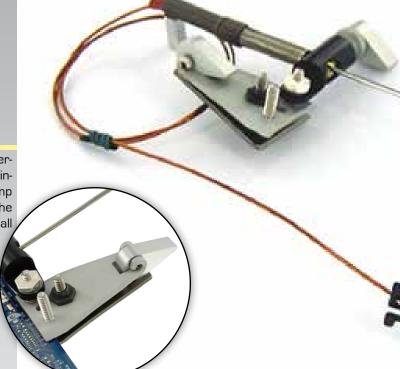
Simply clip the TEMPROBETM to your board, place and lock the thermocouple tip where you like, and you are ready to profile. It has minimal contact area, so heat exchange with PCB is negligible. Clamp features includes a cam actuated locking lever to secure it to the PCB and a second stud for an additional TEMPROBETM and Ball Joint.

Advantage TEMPROBE™:

- Profile the first pass through the oven by placing the TEMPROBE™ thermocouple tip in wet solder paste.
- Profiles are more accurate with TEMPROBE™ because no added material (solder or epoxy) is used for attachment.
- The TEMPROBE™ thermocouple tip is preloaded to maintain high contact pressure throughout the profile.
- TEMPROBE™ makes it easy to take more profiles with greater consistency, to support ISO and SPC data requirements.

Save Money:

- TEMPROBE™ cuts labor, PCB rework and scrap to provide quick payback!
- · No costly sacrificial test boards for temperature profiling.
- No soldering or bonding, so no residue or mechanical damage to the board assembly.
- No need to rerun profiles because a taped down wire lifted off the PCB.



Excellence in Measurem

eratures without soldering or taping!

QUALITY, PRECISION, FUNCTION

The TEMPROBETM sensing element is a subminiature thermocouple, hermetically sealed in a stainless steel sheath. This sheathed thermocouple is designed to insulate it from ambient temperature, and to hold the protruding thermocouple tip in frim thermal contact with the object it is measuring.

HI-TEMP MINI & ECD MICRO CONNECTORS

TEMPROBE™ is available in both hi-temp miniature and ECD Micro connectors that are compatible with most thermal profilers.

SPECIFICATIONS

TEMPROBETM

Maximum reach radius:	5.5in (14cm)
Height with clamp:	0.55 to 0.49in (14 to 12.5mm) above PCB
Weight:	1.6oz. (45g)
Probe material:	Stainless Steel
Temperature limit:	572° F (300° C)
Sensor:	Type K junction
Lead wire:	24in. (60cm) with Kapton® insulation
Special Limits of Error:	Less than ± 1.1° C (Per ANSI

CLAMP (INCLUDED)

Weight:	0.53oz. (15g)
PCB thickness:	Up to 0.30in (7.6mm)
Sensor capacity:	1 or 2 probes

BALL JOINT (INCLUDED)

Weight:	0.42oz (12g)

KIT INCLUDES:

- TEMPROBE™
- Clamp
- Ball Joint
- · Choice of connector ♦ Hi-Temp Miniature or SuperM.O.L.E.® Gold Micro
- · Plastic accessory box and foam

ACCESSORIES:

- TEMPROBE™ Only
 - ♦ SuperM.O.L.E.® Gold Micro (P/N: E45-0764-77)
 - ♦ Hi-Temp Miniature (P/N: E45-0783-77)
- Clamp
 - ♦ (P/N: E40-0200-35)
- Ball Joint
 - ♦ (P/N: E40-0200-30)
- Extension Cable 15ft (4.6m) with Kapton® insulation
 - ♦ 1 Channel (P/N: E40-0200-71)
 - ♦ 2 Channel (P/N: E40-0200-72)

PATENT

U.S. PATENT No. 5,193,912

WARRANTY

WEBSITE

6 months parts and labor

www.ecd.com





ECD North & South America World Headquarters 4287-B SE International Way Milwaukie, Oregon 97222-8825 U.S.A. Tel: +1 503 659 6100/+1 800 323 4548 Fax: +1 503 659 4422 E-Mail: sales@ecd.com | Web: www.ecd.com

ECD Asia/Pacific Singapore Mobile: +65 9692 6822 Fax: +65 6241 9890 E-Mail: ecd.asia@ecd.com

ECD Europe/Africa/Middle East Mobile: +48 512 659 100 E-Mail: ecd.europe@ecd.com

Top rated customer support
No-cost ECD Online Training
Award winning software